

Industry's Lowest Power FPGAs

Whether you're designing today or for the future, power matters. From chip-level to system-level designs, power is the #1 design criterion. Actel's low-power, flash-based FPGAs are optimized to deliver the power and cost that you need to get in the market quickly—and stay in the market for long-term profitability. Actel's flash technology delivers the lowest power and offers a wide range of package size options. You also get the most secure, firm-error immune, live-at-power-up, reprogrammable devices in the industry. For high-volume, low-power, low-cost applications, the Actel IGLOO® and ProASIC®3 series of FPGAs are the perfect choice.



Actel Low-Power Flash FPGAs									
	Indu	IGLOO Series stry's Lowest Power FP	GAs	ProASIC3 Series Low Power FPGAs					
	IGLOO/e	IGLOO nano New!	IGLOO PLUS	ProASIC3/E	ProASIC3 nano New	ProASIC3L			
Overview	The ultra-low-power, programmable solution	The industry's lowest power, smallest size solution	The low-power FPGA with enhanced I/O capabilities	The low-power, low-cost, FPGA solution	Lowest cost solution with enhanced I/O capabilities	The FPGA that balances low power, performance, and low cost			
Applications	Ideal for battery-operated or power-conscious applications, when power and size are key requirements. Provides improved battery runtime or lower operational temperatures.	Designed for consumer, industrial, medical, and other high-volume, low-power applications.	Addresses the need for compact logic density with high I/O count and capability. Ideal for bridging, I/O expansion, level shifting, and memory interfacing applications optimized for low power.	Perfect for designs that require low cost, low power, and performance in small, medium, and large logic densities.	Specifically designed for consumer, industrial, medical, and other high-volume, costsensitive applications. Costeffective replacement for ASICs or ASSPs, delivering faster time-to-market, security, and I/O expansion.	Use in applications that require a balance of performance and low static and dynamic power. Targets applications requiring secure, high-density programmable logic.			
Low-Power Modes	Flash*Freeze technology enables 5 µW static power consumption while maintaining FPGA content.	Flash*Freeze technology enables industry-leading nanoPower consumption while maintaining FPGA content and holding I/O states.	Flash*Freeze mode preserves FPGA content and holds I/O states while the device consumes lowest power.	Supports Sleep mode for power reduction when device is not used.	Supports Sleep mode for power reduction when device is not used.	Flash*Freeze technology enables quick switching to and from low-power mode to reduce dynamic power when FPGA operation is not required.			
Packaging	Small-footprint packages for portable and area-constrained applications, as small as 4x4 mm.	Largest selection of small- footprint packages, as small as 3x3 mm.	High I/O count, small footprint, and low-cost packaging.	Selected small-footprint and low-cost packages, as well as high pin count packages.	Broad selection of small- footprint packages, routable with 2-layer boards in most cases.	Low-cost packages with high pin count.			

	Logic Densities	I/Os	System Performance	Core Voltages	I/O Voltages	Typical Static Power	Power Modes	Packages	Number of ARM® Cortex [™] – M1 Devices	RAM	User Nonvolatile Memory (FlashROM)	PLL
IGLOO/e	15 k–3 M	49–620	200–250 MHz	1.2 V-1.5 V	1.2 V- 3.3 V	5 μW	Flash*Freeze	μCS, CS FBGA, QFN QFP	5	Up to 504 kb	1 kb	Up to 6
IGLOO nano	10 k–250 k	23–71	200–250 MHz	1.2 V-1.5 V	1.2 V- 3.3 V	2 μW	Flash*Freeze	μCS, CS QFN, QFP	_	Up to 36 kb	1 kb	Up to 1
IGLOO PLUS	30 k–125 k	101–21 2	200–250 MHz	1.2 V-1.5 V	1.2 V- 3.3 V	5 μW	Flash*Freeze	CS, QFP	_	Up to 36 kb	1 kb	Up to 1
ProASIC3/E	15 k–3 M	49–620	350 MHz	1.5 V	1.5 V- 3.3 V	3 mW	Sleep	FBGA, QFN QFP	6	Up to 504 kb	1 kb	Up to 6
ProASIC3 nano New!	10 k–250 k	34–71	350 MHz	1.5 V	1.5 V- 3.3 V	1.5 mW	Sleep	QFN, QFP	_	Up to 36 kb	1 kb	Up to 1
ProASIC3L	250 k-3 M	68–620	250- 350 MHz	1.2 V-1.5 V	1.2 V- 3.3 V	400 μW	Flash*Freeze	FBGA, QFP	3	Up to 504 kb	1 kb	Up to 6

For more information, please visit the Actel website at www.actel.com or contact your local sales representative.

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